

Excellent Integrated System Limited

Stocking Distributor

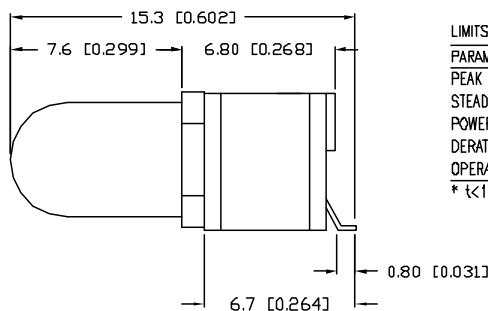
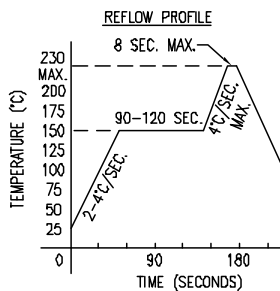
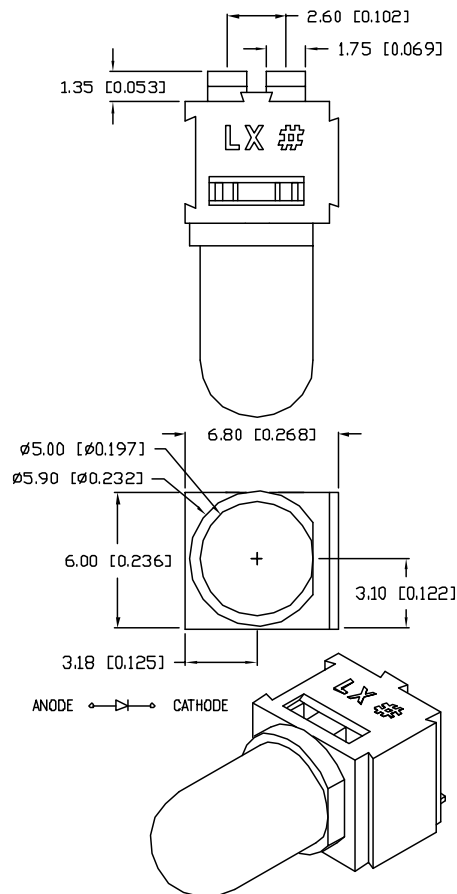
Click to view price, real time Inventory, Delivery & Lifecycle Information:

[Lumex, Inc.](#)
[SMF-HM1530GD-509](#)

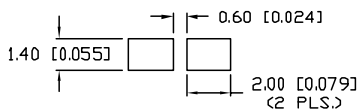
For any questions, you can email us directly:

sales@integrated-circuit.com

UNCONTROLLED DOCUMENT



RECOMMENDED SOLDER PAD LAYOUT



PART NUMBER			REV.
SMF-HM1530GD-509			B
REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE	
A	E.C.N. #10683.	11.29.00	
B	E.C.N. #11148.	01.15.07	

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$					
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		2.2	2.6	V _f	
REVERSE VOLTAGE	5.0			V _r	$I_r=100\mu\text{A}$
AXIAL INTENSITY		30		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	GREEN				
EPOXY LENS FINISH:	GREEN DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.6	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C

* $t < 10\mu\text{s}$

NOTES:

- SSL-LX5093GD, GREEN LED, TRIM LEADS TO 5.35mm MAX.
- SMS-LXU1530, SURFACE MOUNT SOCKET.

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*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN=+DECIMAL PRECISION MAX=-DECIMAL PRECISION

REV.	PART NUMBER	CONFIDENTIAL INFORMATION	LUMEX	290 E. HELEN ROAD PALATINE, IL 60067-6976 PHONE: +1.847.359.2790 US WEB: www.lumex.com TW WEB: www.lumex.com.tw
B	SMF-HM1530GD-509	THE INFORMATION CONTAINED IN THIS DOCUMENT IS THE PROPERTY OF LUMEX INC. EXCEPT AS SPECIFICALLY AUTHORIZED IN WRITING BY LUMEX INC., THE HOLDER OF THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.		
SURFACE MOUNT SOCKET FAULT INDICATOR, T-5mm (T-1 3/4) GREEN LED, GREEN DIFFUSED LENS.		RELIABILITY NOTE OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.	DRAWN BY: JC	CHECKED BY: APPROVED BY: DATE: 3.23.00 PAGE: 1 OF 1 SCALE: N/A